# Mini-SAS (FS Series)



The Mini-SAS external I/O connector system consists of a die-cast metal cage and a Compact MultiLane SMT Connector, featuring proven "cut edge" style contacts. Providing four serial send/receive channels per port, this connector system is designed to satisfy the needs for gigabit serial data transmission applications with signal speeds across the connector interface of 6 Gbps per channel.

The cage is mounted separately to the body so that the stress imposed by insertion and removal of the cable plug does not affect the signal/body solder joints. The connector is available with unique solder hold-down tabs designed to provide additional mechanical robustness in demanding applications.



# **Specification Highlights**

The Mini-SAS interconnect system is comprised of a cage assembly which is used with 26-position, 0.8mm pitch connectors complying with SFF-8086 and SFF-8088.

#### **Mechanical Characteristics**

- Co-Planarity Specification: 0.1 mm
- Connector Insertion Force: 55.5 N max
- Connector Withdrawal Force: 49.0 N max
- Durability: 250 Mating Cycles min
- Reverse Keying for Active Copper Cables per SAS 2.0

#### **Electrical Characteristics**

- Operating Voltage: 30 V
- Operating Current: 0.5 A
- Differential Impedance:  $100 \Omega + 10 \Omega$
- DWV: 300 V AC
- Insulation Resistance: 1000 MΩ min
- Contact Resistance: 80 mΩ max
- Near-End Isolation: -40 dB (frequencies up to 3 GHz)
- Insertion Loss: 1.0 dB max (frequencies up to 1.6 GHz)
- Rise Time for Impedance Measurement: 50 ps
- Within Pair Skew: 5 ps

#### Packaging

- Tape and Reel Packaging: Connector
- Tray Packaging: Cage
- Bulk Packaging: Mounting Screw or Dust Cover

#### Materials

- Cage
  - o Base Material: Zinc Alloy
  - o Plating: Nickel
  - o Mounting Screw: AISI 1010 Steel
  - o Light Pipe: Optical Grade Polycarbonate
  - o Dust Cover: Thermoplastic
  - Connector
  - o Contact Base Material: Copper Alloy
  - o Contact Plating: Gold on Mating Area, Matte Tin on Termination
  - o Housings: Glass Reinforced, Lead-Free Solder Reflow Process Compatible Thermoplastic, UL94V-0 Rated

#### **Temperature Rating**

- Operating Temperature: -55°C to +85°C
- Storage Temperature: -55°C to +85°C

## Configurations (Rows x Ports per Row)

- 1x1 1x2
- 1x4

## Options

- Dust Cover
- Light Pipe
- EMI Shielding
  - o Conductive Elastomeric Gasket
  - o Soft Shield Foam Gasket
  - o Stainless Steel Gasket
- Cage Inclination from Printed Circuit Board o 0 degree Angle
- o 1 degree Angle (PCI Applications)
- Keying



# **Ordering Information**



